

SOT-23 Plastic-Encapsulate MOSFETS

Features

- $V_{DS} = -30V$
- $I_D = -2.6A$
- $R_{DS(on)}@V_{GS} = -10V < 90m\Omega$
- $R_{DS(on)}@V_{GS} = -4.5V < 150m\Omega$
- Trench Power MV MOSFET technology
- Voltage controlled small signal switch
- Fast Switching Speed

Applications

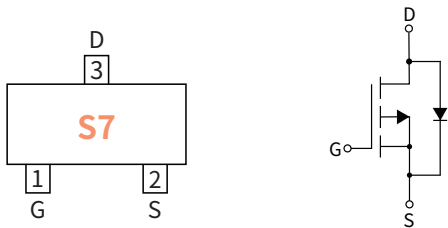
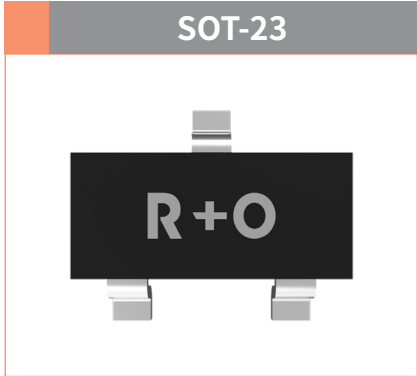
- Battery operated systems
- Solid-state relays
- Direct logic-level interface: TTL/CMOS

Mechanical Data

- Case: SOT-23
Molding compound meets UL 94V-0 flammability rating, RoHS-compliant, halogen-free
- Terminals: Solder plated, solderable per MIL-STD-750, Method 2026

Reference News

Drain-source Voltage
-30 V
Drain Current
-2.6 Ampere



Maximum Ratings (Ta=25°C Unless otherwise specified)

PARAMETER		SYMBOL	UNIT	VALUE
Drain-source Voltage		V_{DS}	V	-30
Gate-source Voltage		V_{GS}	V	± 20
Drain Current ⁽¹⁾⁽²⁾	$T_A = 25^\circ C$ @ Steady State	I_D	A	-2.6
Pulsed Drain Current ⁽¹⁾⁽²⁾		I_{DM}	A	-15
Total Power Dissipation @ $T_A = 25^\circ C$		P_D	W	1.0
Thermal Resistance Junction-to-Ambient @ Steady State		$R_{\theta JA}$	$^\circ C / W$	125
Junction and Storage Temperature Range		T_J, T_{STG}	$^\circ C$	-55 ~ +150

Note :
(1) Surface mounted on FR4 board.
(2) $t \leq 5$ sec.

Ordering Information

PACKAGE	PACKAGE CODE	UNIT WEIGHT(g)	REEL(pcs)	BOX(pcs)	CARTON(pcs)	DELIVERY MODE
SOT-23	R1	0.008	3000	45000	180000	7"

● Static Parameter Characteristics (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	Condition	UNIT	Min	Typ	Max
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=-250\mu A$	V	-30	—	—
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=-30V, V_{GS}=0V$	μA	—	—	-1.0
Gate-Body Leakage Current	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$	nA	—	—	± 100
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\mu A$	V	-1.0	-1.6	-2.2
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=-10V, I_D=-2.6A$	m Ω	—	77	90
		$V_{GS}=-4.5V, I_D=-2.0A$		—	125	150
Diode Forward Voltage	V_{SD}	$I_S=-1.0A, V_{GS}=0V$	V	—	—	-1.0

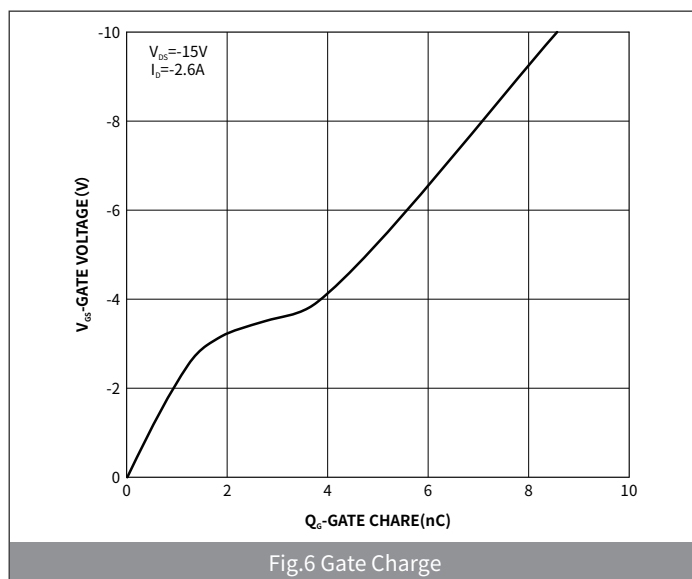
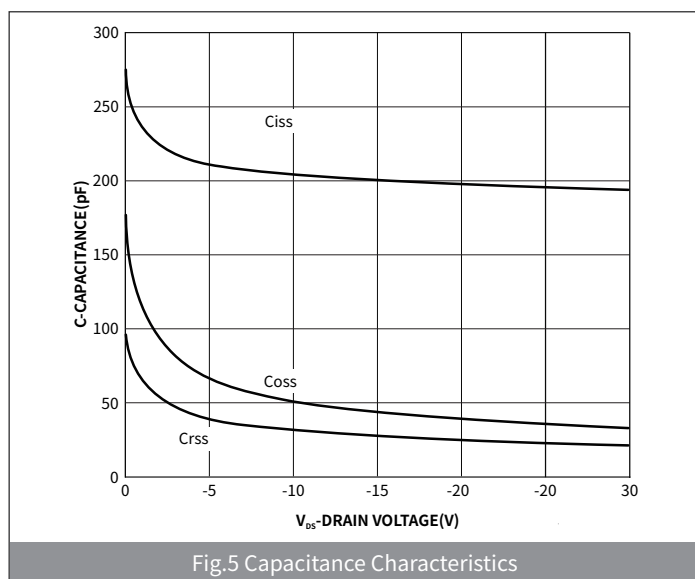
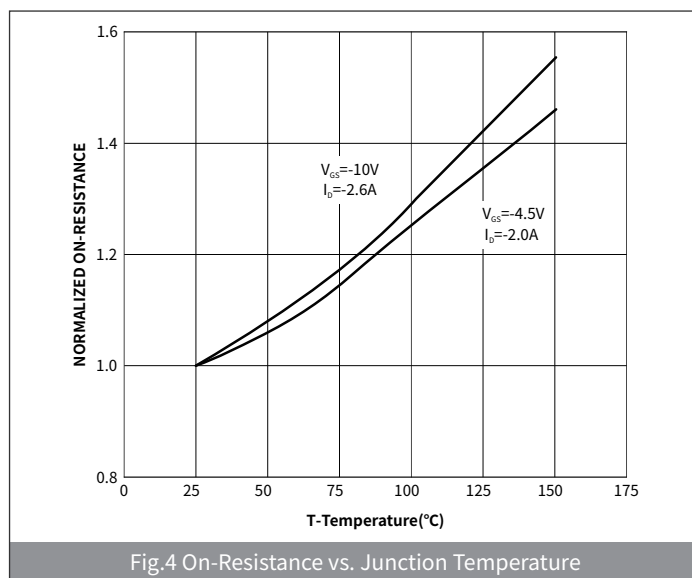
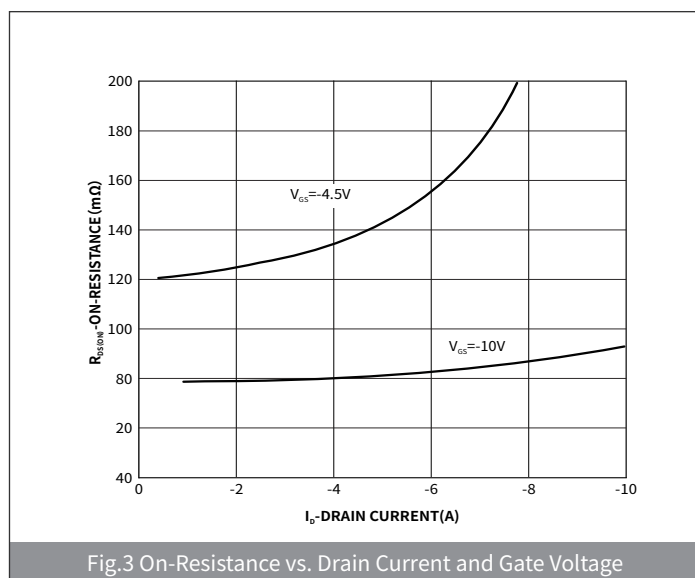
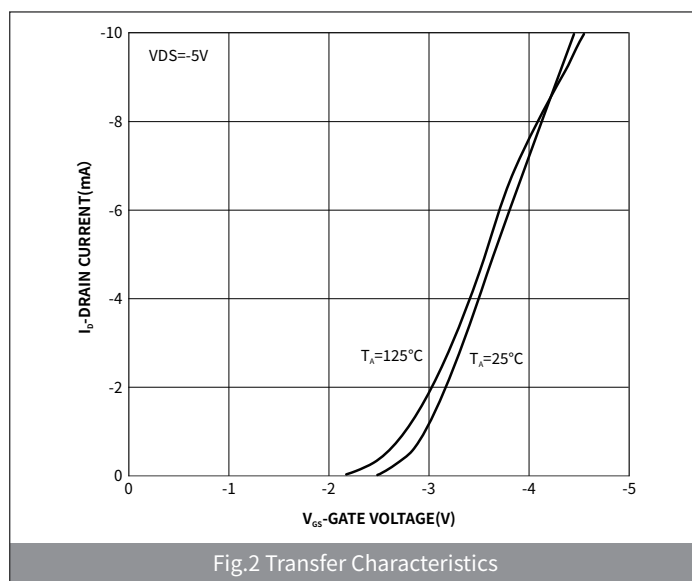
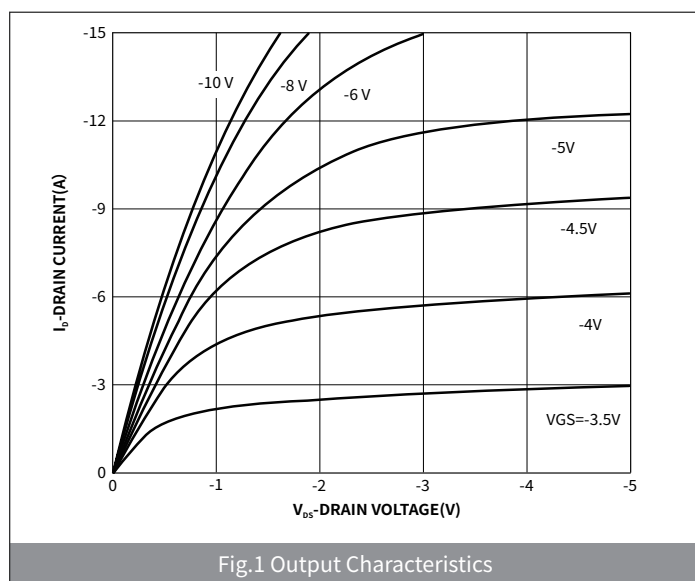
● Dynamic Parameters (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	Condition	UNIT	Min	Typ	Max
Input Capacitance	C_{iss}	$V_{DS}=-15V$ $V_{GS}=0V$ $f=1MHz$	pF	—	200	—
Output Capacitance	C_{oss}			—	45	—
Reverse Transfer Capacitance	C_{rss}			—	30	—

● Switching Parameters (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	Condition	UNIT	Min	Typ	Max
Total Gate Charge	Q_g	$V_{GS}=-15V$ $V_{DS}=-10V$ $I_D=-2.6A$	nC	—	4.0	—
Gate-Source Charge	Q_{gs}			—	1.0	—
Gate-Drain Charge	Q_{gd}			—	1.0	—
Turn-on Delay Time	$t_{D(on)}$	$V_{GS}=-10V$ $V_{DS}=-15V$ $R_{GEN}=3.0\Omega$ $I_D=-1.0A$	ns	—	8.0	—
Turn-on Rise Time	t_r			—	4.0	—
Turn-off Delay Time	$t_{D(off)}$			—	12	—
Turn-off fall Time	t_f			—	4.0	—

● Ratings And Characteristics Curves ($T_a=25^\circ\text{C}$ Unless otherwise specified)



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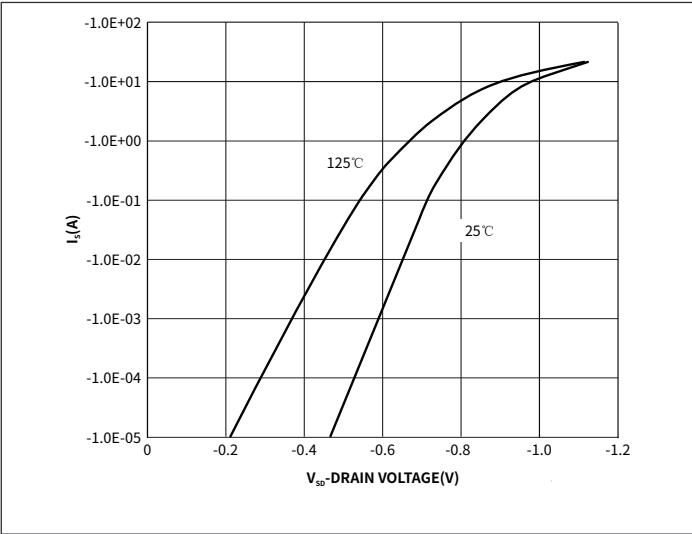


Fig.7 Diode Characteristics

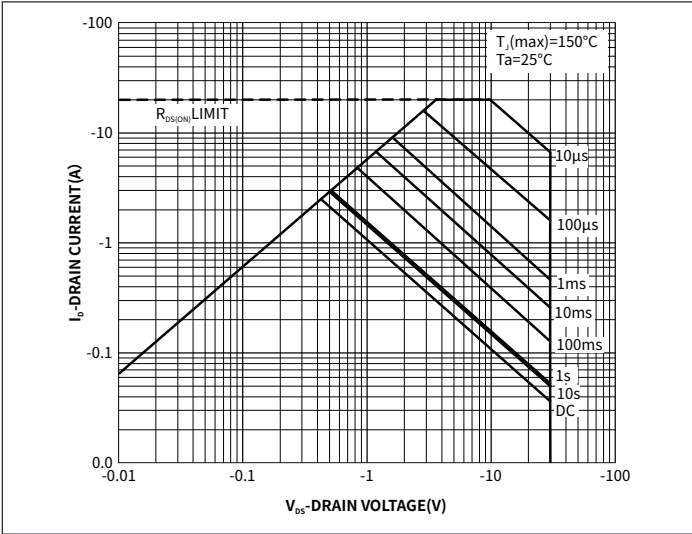


Fig.8 Safe Operating Area

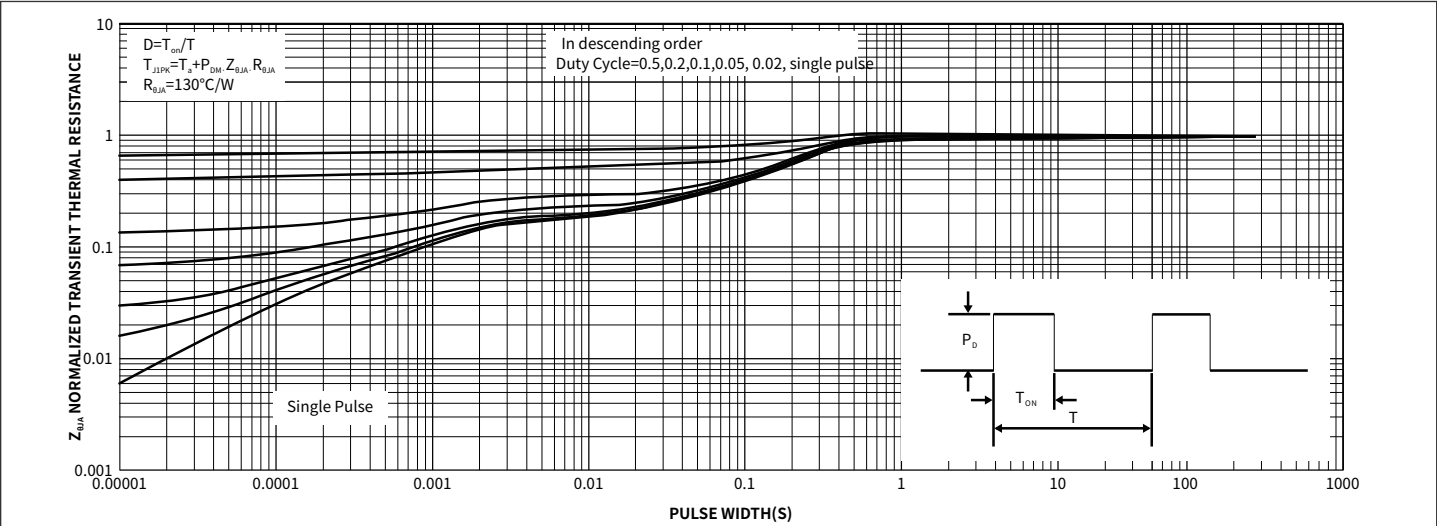
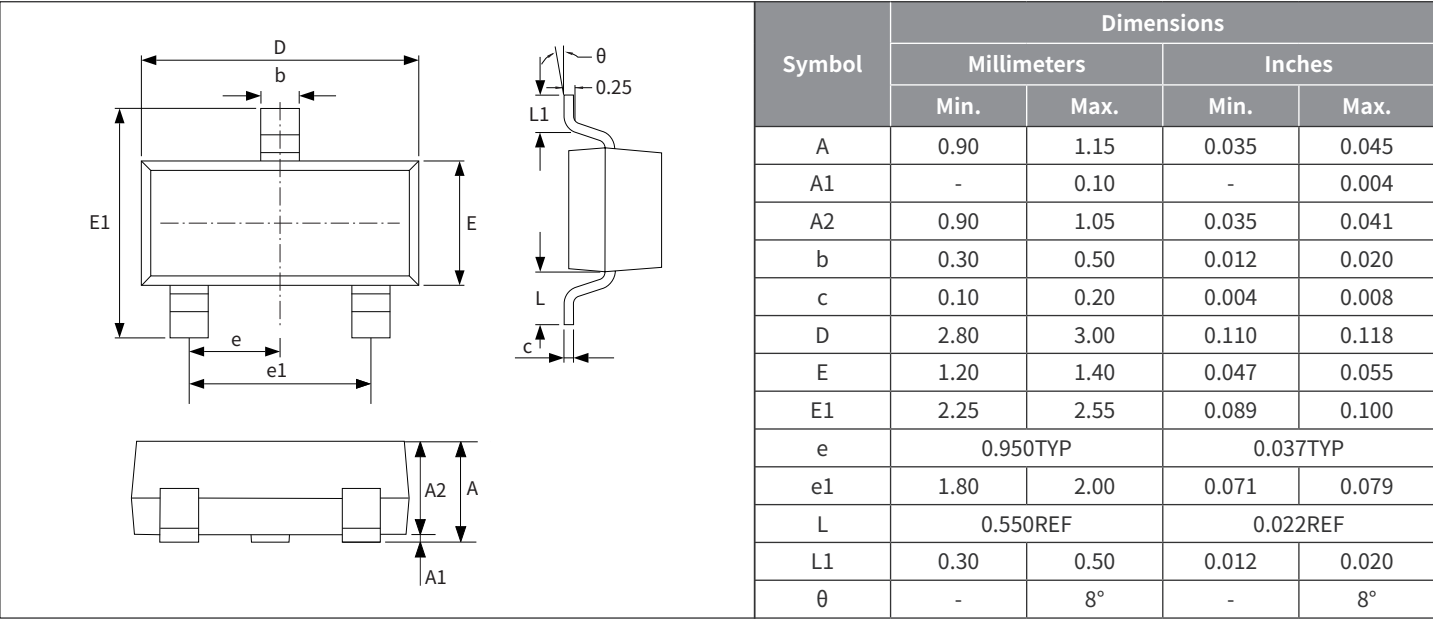


Fig.9 Normalized Maximum Transient Thermal Impedance

● Package Outline Dimensions (SOT-23)



● Suggested Pad Layout

